PATENT NUMBER and ISSUE DATE **U.S. UTILITY** Patent Application 1446 70 000 APPL NUM **FILING DATE** CLASS **SUBCLASS EXAMINER** 10025438 12/19/2001 Nguyen, Ha *APPLICANTS: Fazelpour Siamak; *CONTINUING DATA VERIFIED: m T .- 7+ * FOREIGN APPLICATIONS VERIFIED: nne in PG-PUB DO NOT PUBLISH 🖾 RESCIND -Foreign priority claimed ⊒ yes ⊋rno ATTORNEY DOCKET NO 35 USC 119 conditions met □ ves 20 no Verified and Acknowledged Examiners's intials 01CON272P TITLE: Method for integrating passives on-die utilizing under bump metal and related structure NOTICE OF ALLOWANCE MAILED CLAIMS ALLOWED 0.6 Assistant Examiner Amount Due Date Paid Primary Examiner Application Examiner TERMINAL PREPARED FOR ISSUE DISCLAMER WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35; # Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark.

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